



SamHop Microelectronics Corp.



STM101N

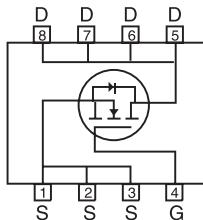
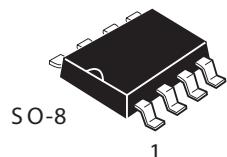
Ver1.0

N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
V _{DSS}	ID	R _{DSON} (mΩ) Typ
100V	3A	170 @ V _{GS} =10V
		260 @ V _{GS} =4.5V

FEATURES

- Super high dense cell design for low R_{DSON}.
- Rugged and reliable.
- Surface Mount Package.



ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Symbol	Parameter		Limit	Units
V _{DS}	Drain-Source Voltage		100	V
V _{GS}	Gate-Source Voltage		±20	V
I _D	Drain Current-Continuous ^a	T _A =25°C	3	A
		T _A =70°C	2.4	A
I _{DM}	-Pulsed ^b		15	A
E _{AS}	Sigle Pulse Avalanche Energy ^d		2.3	mJ
P _D	Maximum Power Dissipation ^a	T _A =25°C	2.8	W
		T _A =70°C	1.8	W
T _J , T _{STG}	Operating Junction and Storage Temperature Range		-55 to 150	°C

THERMAL CHARACTERISTICS

R _{θJA}	Thermal Resistance, Junction-to-Ambient ^a	44	°C/W
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Details are subject to change without notice.

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ELECTRICAL CHARACTERISTICS ($T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	100			V
$I_{DS(on)}$	Zero Gate Voltage Drain Current	$V_{DS}=80V, V_{GS}=0V$		1		μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	1.8	3	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=1.5A$		170	210	m ohm
		$V_{GS}=4.5V, I_D=1A$		260	350	m ohm
g_{FS}	Forward Transconductance	$V_{DS}=10V, I_D=1.5A$		5.5		S
DYNAMIC CHARACTERISTICS ^c						
C_{iss}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V$ $f=1.0MHz$		310		pF
C_{oss}	Output Capacitance			35		pF
C_{rss}	Reverse Transfer Capacitance			20		pF
SWITCHING CHARACTERISTICS ^c						
$t_{D(on)}$	Turn-On Delay Time	$V_{DD}=50V$ $I_D=1A$ $V_{GS}=10V$ $R_{GEN}=6\text{ ohm}$		8		ns
t_r	Rise Time			9		ns
$t_{D(off)}$	Turn-Off Delay Time			16.5		ns
t_f	Fall Time			3.5		ns
Q_g	Total Gate Charge	$V_{DS}=50V, I_D=1.5A, V_{GS}=10V$		5.5		nC
Q_{gs}	Gate-Source Charge	$V_{DS}=50V, I_D=1.5A,$ $V_{GS}=10V$		1		nC
Q_{gd}	Gate-Drain Charge			2		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=1A$		0.785	1.3	V
Notes						
a. Surface Mounted on FR4 Board, $t \leq 10\text{ sec}$.						
b. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.						
c. Guaranteed by design, not subject to production testing.						
d. Starting $T_J=25^\circ C$, $L=0.5\text{mH}$, $V_{DD}=50V$, $V_{GS}=10V$. (See Figure13)						

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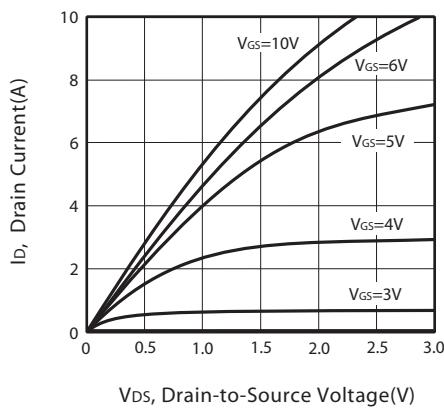


Figure 1. Output Characteristics

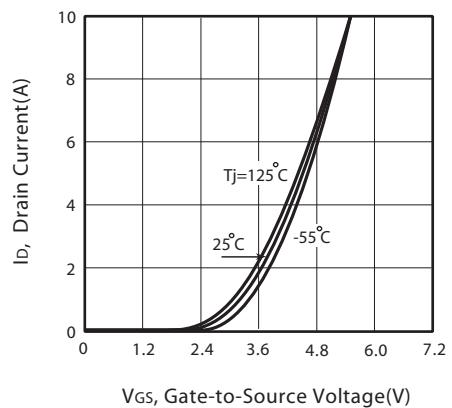


Figure 2. Transfer Characteristics

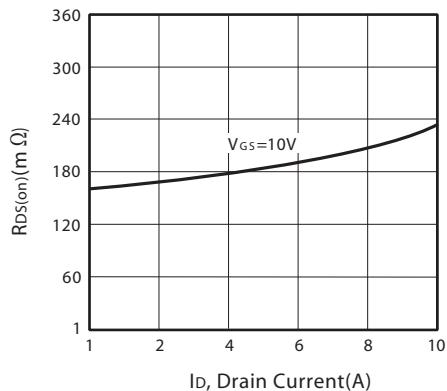


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

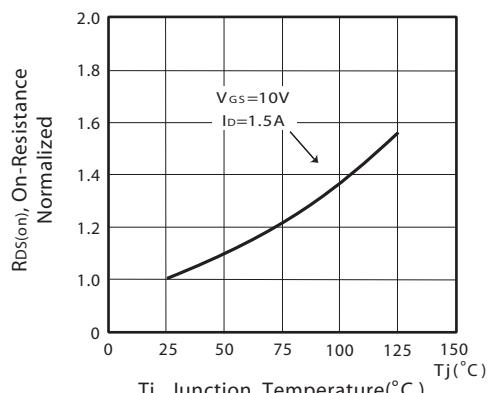


Figure 4. On-Resistance Variation with Drain Current and Temperature

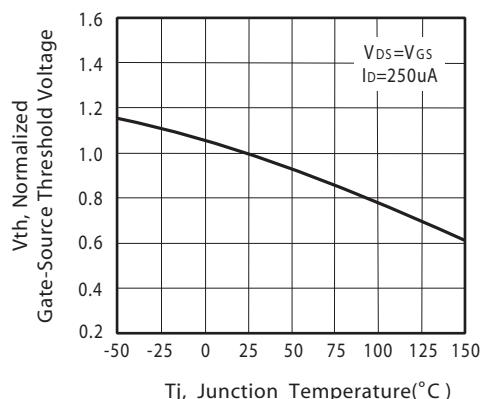


Figure 5. Gate Threshold Variation with Temperature

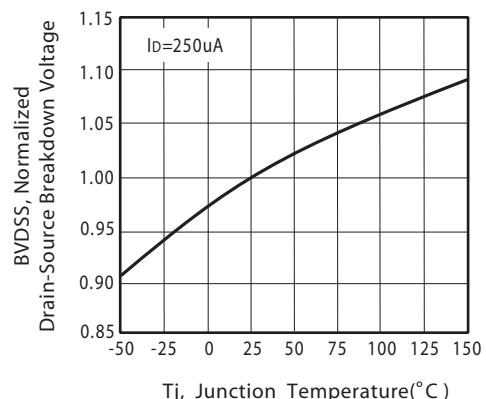
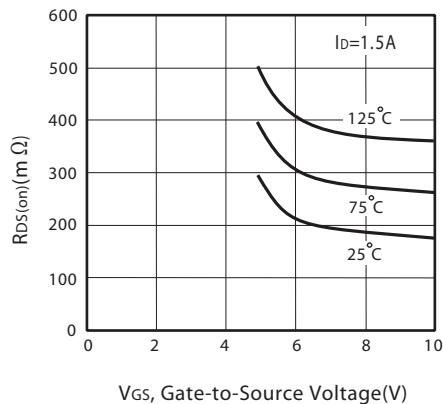


Figure 6. Breakdown Voltage Variation with Temperature

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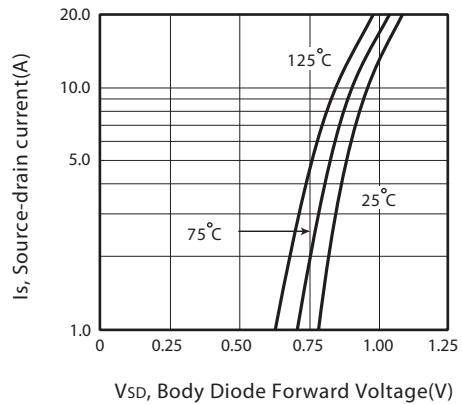
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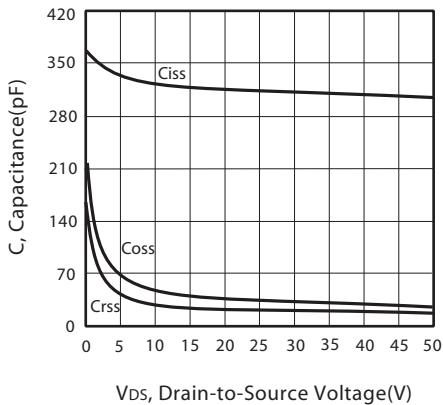
V_{GS}, Gate-to-Source Voltage(V)

Figure 7. On-Resistance vs. Gate-Source Voltage



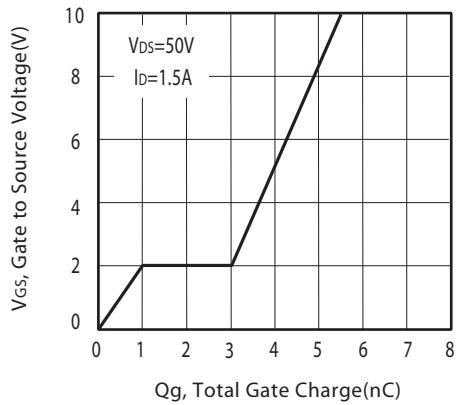
V_{SD}, Body Diode Forward Voltage(V)

Figure 8. Body Diode Forward Voltage Variation with Source Current



V_{DS}, Drain-to-Source Voltage(V)

Figure 9. Capacitance



Q_g , Total Gate Charge(nC)

Figure 10. Gate Charge

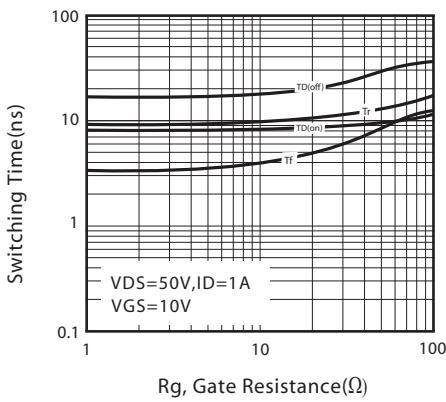


Figure 11. switching characteristics

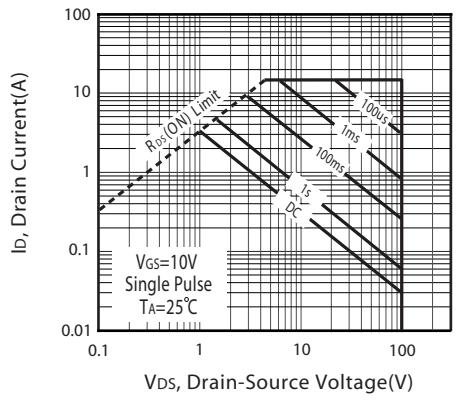
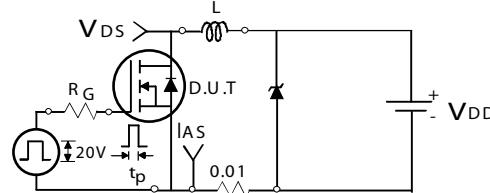


Figure 12. Maximum Safe Operating Area

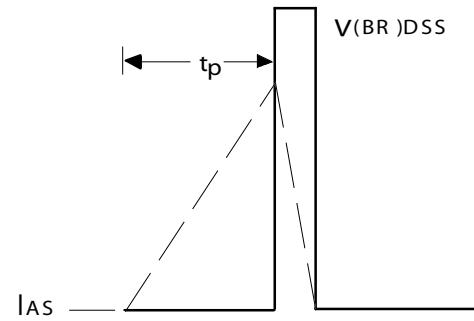
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Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

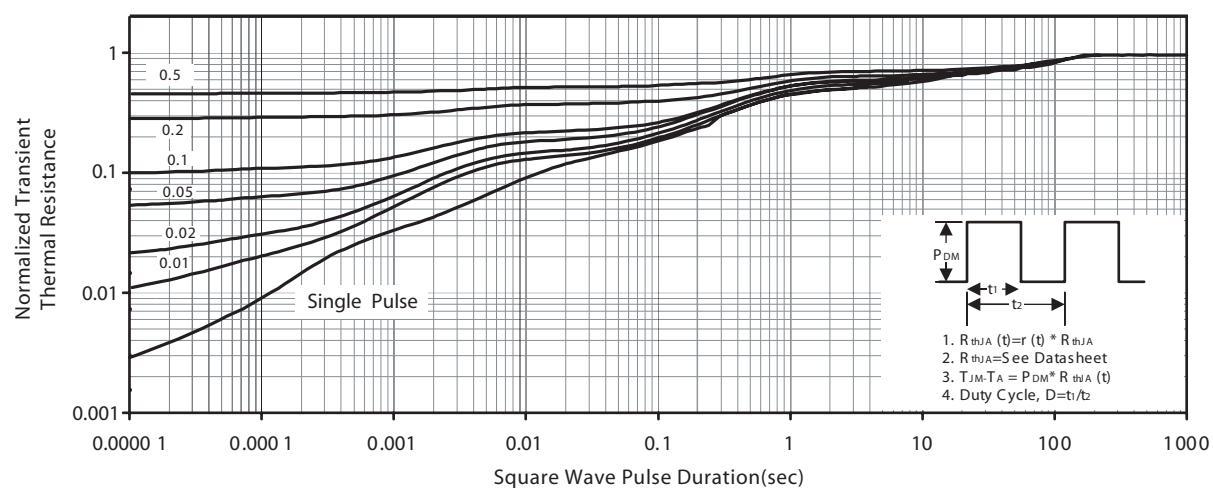
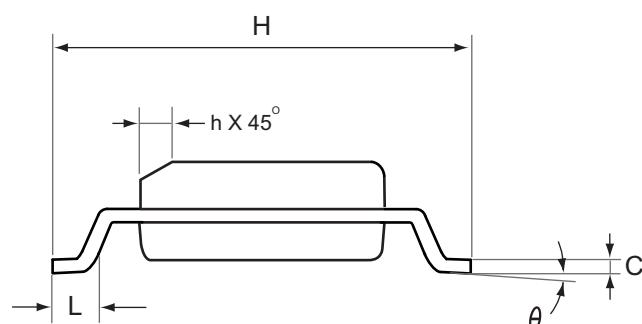
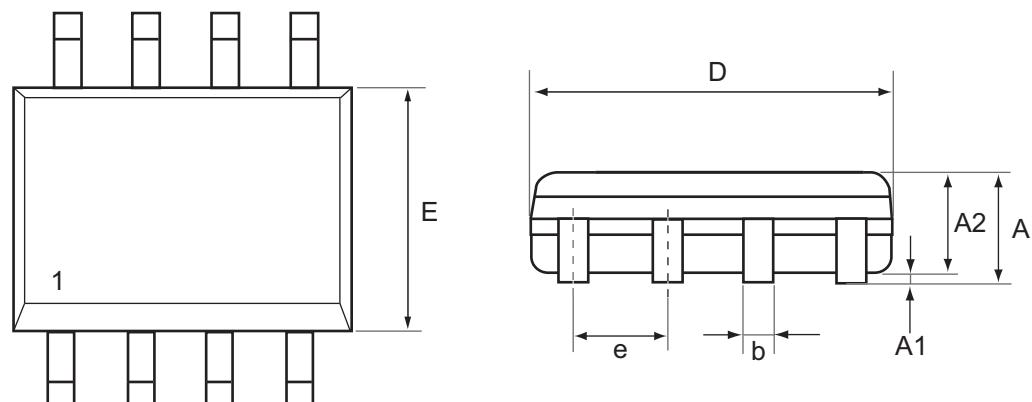


Figure 14. Normalized Thermal Transient Impedance Curve

PACKAGE OUTLINE DIMENSIONS

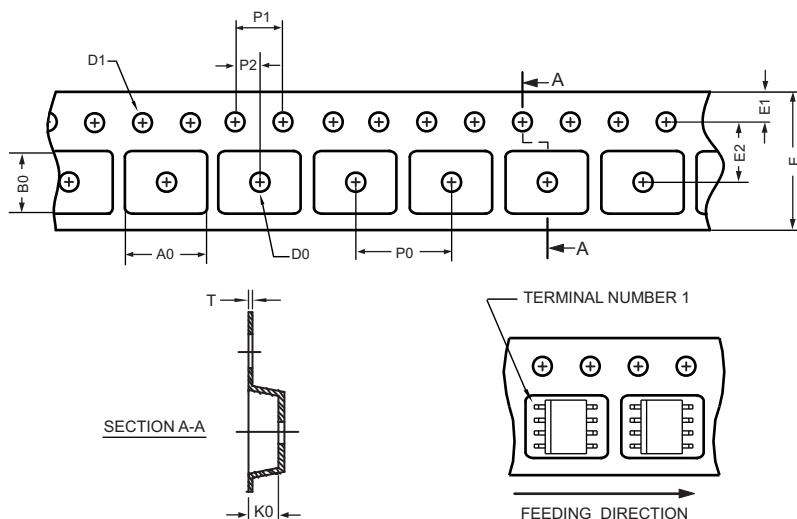
SO-8



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
A2	1.25	1.63	0.049	0.064
b	0.31	0.51	0.012	0.020
C	0.17	0.25	0.007	0.010
D	4.80	5.00	0.189	0.197
E	3.70	4.00	0.146	0.157
e	1.27 REF.		0.050 BSC	
H	5.80	6.20	0.228	0.244
L	0.40	1.27	0.016	0.050
θ	0 °	8 °	0 °	8 °
h	0.25	0.50	0.010	0.020

SO-8 Tape and Reel Data

SO-8 Carrier Tape



unit:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOP 8N 150mil	6.50 ± 0.15	5.25 ± 0.10	2.10 ± 0.10	$\phi 1.5$ (MIN)	$\phi 1.55$ ± 0.10	12.0 $+0.3$ -0.1	1.75 ± 0.10	5.5 ± 0.10	8.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.10	0.30 ± 0.013

SO-8 Reel

